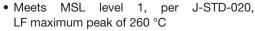


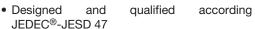
# Thyristor High Voltage Surface Mount Phase Control SCR, 10 A

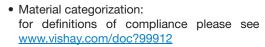


PRODUCT SUMMARY						
Package	TO-263AB (D <sup>2</sup> PAK)					
Diode variation	Single SCR					
I <sub>T(AV)</sub>	6.5 A					
V <sub>DRM</sub> /V <sub>RRM</sub>	800 V					
V <sub>TM</sub>	< 1.15 V					
I <sub>GT</sub>	15 mA					
TJ	-40 to +125 °C					

#### **FEATURES**











ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- · Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

#### **DESCRIPTION**

The VS-10TTS08SPbF high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS								
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS								
NEMA FR-4 or G-10 glass fabric-based epoxy with 4 oz. (140 μm) copper	2.5	3.5						
Aluminum IMS, R <sub>thCA</sub> = 15 °C/W	6.3	9.5	A					
Aluminum IMS with heatsink, R <sub>thCA</sub> = 5 °C/W	14.0	18.5						

#### Note

• T<sub>A</sub> = 55 °C, T<sub>J</sub> = 125 °C, footprint 300 mm<sup>2</sup>

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
I <sub>T(AV)</sub>	Sinusoidal waveform	6.5	A					
I <sub>RMS</sub>		10	A					
V <sub>RRM</sub> /V <sub>DRM</sub>		800	V					
I <sub>TSM</sub>		110	A					
V <sub>T</sub>	6.5 A, T <sub>J</sub> = 25 °C	1.15	V					
dV/dt		150	V/µs					
dl/dt		100	A/µs					
TJ	Range	-40 to +125	°C					

<b>VOLTAGE RATINGS</b>			
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	I <sub>RRM</sub> /I <sub>DRM</sub> AT 125 °C mA
VS-10TTS08SPbF	800	800	1.0



PARAMETER	SYMBOL	TEST COL	NDITIONS	VALUES	UNITS	
		1231 001		UNITS		
Maximum average on-state current	I <sub>T(AV)</sub>	T <sub>C</sub> = 112 °C, 180° conduction half sine wave			4	
Maximum RMS on-state current	I <sub>T(RMS)</sub>			10	Α	
Maximum peak, one-cycle,	l=	10 ms sine pulse, rated V <sub>F</sub>	$_{RRM}$ applied, $T_{J}$ = 125 °C	95	/ \	
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine pulse, no volta	ige reapplied, T <sub>J</sub> = 125 °C	110		
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	10 ms sine pulse, rated V <sub>F</sub>	RRM applied, T <sub>J</sub> = 125 °C	45	A <sup>2</sup> s	
waximum i-t for fusing	1-1	10 ms sine pulse, no volta	64	A <sup>2</sup> S		
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no vo	640	A²√s		
Maximum on-state voltage drop	V <sub>TM</sub>	6.5 A, T <sub>J</sub> = 25 °C	1.15	V		
On-state slope resistance	r <sub>t</sub>	T 405 %		17.3	mΩ	
Threshold voltage	V <sub>T(TO)</sub>	T <sub>J</sub> = 125 °C		0.85	V	
Maximum variance and direct leakage current	1 //	T <sub>J</sub> = 25 °C	V Detect V A	0.05		
Maximum reverse and direct leakage current	I <sub>RM</sub> /I <sub>DM</sub>	T <sub>J</sub> = 125 °C	V <sub>R</sub> = Rated V <sub>RRM</sub> /V <sub>DRM</sub>	1.0		
Typical holding current	I <sub>H</sub>	Anode supply = 6 V, resist $T_J = 25 ^{\circ}\text{C}$	30	mA		
Maximum latching current	ΙL	Anode supply = 6 V, resist	50			
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80 \text{ %, } V_{DRM} = R_g - k = Open$			V/µs	
Maximum rate of rise of turned-on current	dl/dt		100	A/µs		

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	$P_{GM}$		8.0	W				
Maximum average gate power	P <sub>G(AV)</sub>		2.0	VV				
Maximum peak positive gate current	+I <sub>GM</sub>		1.5	А				
Maximum peak negative gate voltage	-V <sub>GM</sub>		10	V				
Maximum required DC gate current to trigger	I <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = - 65 °C	20	mA				
		Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	15					
		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	10					
		Anode supply = 6 V, resistive load, T <sub>J</sub> = - 65 °C	1.2					
Maximum required DC gate voltage to trigger	$V_{GT}$	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	1	V				
voltage to trigger		Anode supply = 6 V, resistive load, T <sub>J</sub> = 125 °C	0.7	V				
Maximum DC gate voltage not to trigger	$V_{GD}$	T 105 °C V Detectively	0.2					
Maximum DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = 125 °C, V <sub>DRM</sub> = Rated value	0.1	mA				

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.8	
Typical reverse recovery time	t <sub>rr</sub>	T = 105 °C	3	μs
Typical turn-off time	t <sub>q</sub>	T <sub>J</sub> = 125 °C	100	

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +125	°C				
Soldering temperature	T <sub>S</sub>	For 10 s (1.6 mm from case)	260	]				
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	1.5	°C/W				
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> <sup>(1)</sup>		40	C/VV				
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
Marking device		Case style D <sup>2</sup> PAK (SMD-220)	10TTS	08S				

#### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

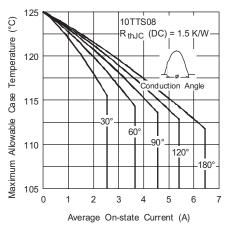


Fig. 1 - Current Rating Characteristics

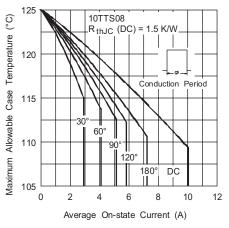


Fig. 2 - Current Rating Characteristics

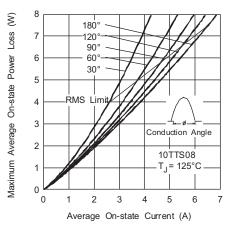


Fig. 3 - On-State Power Loss Characteristics

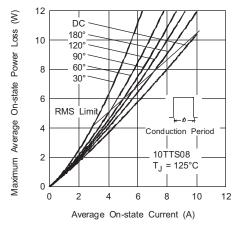


Fig. 4 - On-State Power Loss Characteristics

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## Vishay Semiconductors

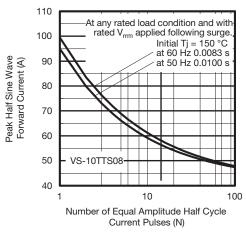


Fig. 5 - Maximum Non-Repetitive Surge Current

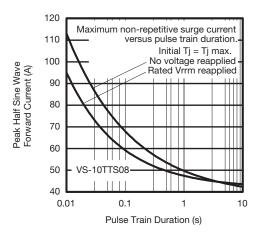


Fig. 6 - Maximum Non-Repetitive Surge Current

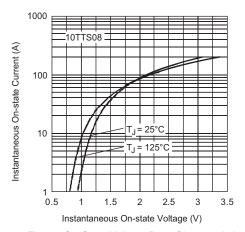


Fig. 7 - On-State Voltage Drop Characteristics

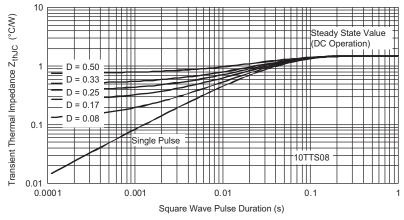
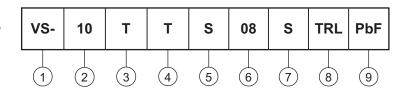


Fig. 8 - Thermal Impedance Z<sub>thJC</sub> Characteristics



### **ORDERING INFORMATION TABLE**

Device code



- 1 Vishay Semiconductors product
- Current rating, RMS value
- 3 Circuit configuration:

T = single thyristor

- 4 Package:
  - T = TO-220AC
- 5 Type of silicon:

S = converter grade

- Voltage code x 100 = V<sub>RRM</sub>
- 7 S = TO-220 D<sup>2</sup>PAK (SMD-220) version
- 8 Tape and reel option:
  - TRL = tape and reel (left oriented)
  - TRR = tape and reel (right oriented)
- 9 PbF = lead (Pb)-free

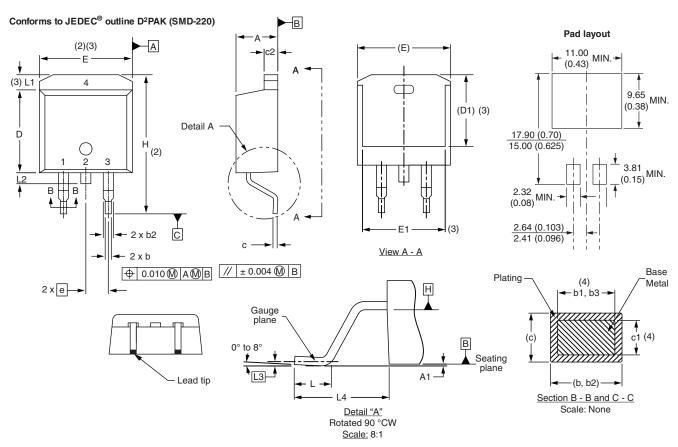
ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-10TTS08SPbF	50	1000	Antistatic plastic tubes					
VS-10TTS08STRRPbF	800	800	13" diameter reel					
VS-10TTS08STRLPbF	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95046</u>						
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					



# D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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